Surface Mount Ultrafast Power Rectifiers

POWERMITE[®] Power Surface Mount Package

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Supplied in 12 mm Tape and Reel
 - TR7 Suffix = 3,000 Units per Reel
 - TR13 Suffix = 12,000 Units per Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

Mechanical Characteristics:

- Powermite is JEDEC Registered as D0-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 62 mg (approximately)
- ESD Ratings: Machine Model = C Human Body Model = 3B
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage UPR5 Series UPR10 Series	V _{RRM} V _{RWM} V _R	50 100	V
Average Rectified Forward Current (At Rated V_R , $T_L = 95^{\circ}C$)	I _{F(AV)}	2.0	A
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	50	A
Operating Junction Temperature Range	TJ	–65 to +150	°C
Storage Temperature Range	T _{stg}	–65 to +150	°C



ON Semiconductor**

http://onsemi.com

ULTRAFAST RECTIFIERS 2.0 AMPERES 100 VOLTS



POWERMITE CASE 457 PLASTIC

MARKING DIAGRAM



M = Date Codex = A or B

2UA = UPR5 Series Device Code 2UB = UPR10 Series Device Code

ORDERING INFORMATION

Device	Package	Shipping
UPR5TR7	POWERMITE	3,000/Tape & Reel
UPR5TR13	POWERMITE	12,000/Tape & Reel
UPR10TR7	POWERMITE	3,000/Tape & Reel
UPR10TR13	POWERMITE	12,000/Tape & Reel

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance – Junction–to–Lead (Anode) (Note 1)	R _{tjl}	35	°C/W
– Junction–to–Tab (Cathode) (Note 1)	R _{tjtab}	23	
– Junction–to–Ambient (Note 1)	R _{tja}	277	

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Maximum Instantaneous Forward Voltage	V _F	T _J = 25°C	T _J = 100°C	V
(I _F = 1.0 A) (I _F = 2.0 A)		0.830 0.905	0.680 0.740	
Maximum Instantaneous Reverse Current	Ι _R	T _J = 25°C	T _J = 100°C	μΑ
(V _R = Max Rating)		2.0	50	
Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/µs, V _R = 30 V, T _J = 25°C)	T _{RR}	30		ns
Typical Reverse Recovery Time $(I_F = 0.1 \text{ A}, I_R = 0.2 \text{ A}, I_{REC} = 50 \text{ mA})$	T _{RR}	6		ns

1. Mounted with minimum recommended pad size, PC Board FR4. See Figures 7 and 8.







Figure 2. Maximum Forward Voltage



UPR5 Series



Figure 8. Thermal Response Junction to Ambient

UPR5 Series

PACKAGE DIMENSIONS

POWERMITE CASE 457–04 ISSUE D





^{1.} DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER. DIMENSION A DOES NOT INCLIDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.75	2.05	0.069	0.081
В	1.75	2.18	0.069	0.086
C	0.85	1.15	0.033	0.045
D	0.40	0.69	0.016	0.027
F	0.70	1.00	0.028	0.039
Н	-0.05	+0.10	-0.002	+0.004
J	0.10	0.25	0.004	0.010
K	3.60	3.90	0.142	0.154
L	0.50	0.80	0.020	0.031
R	1.20	1.50	0.047	0.059
S	0.50 REF		0.019 REF	



Minimum Recommended Footprint

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